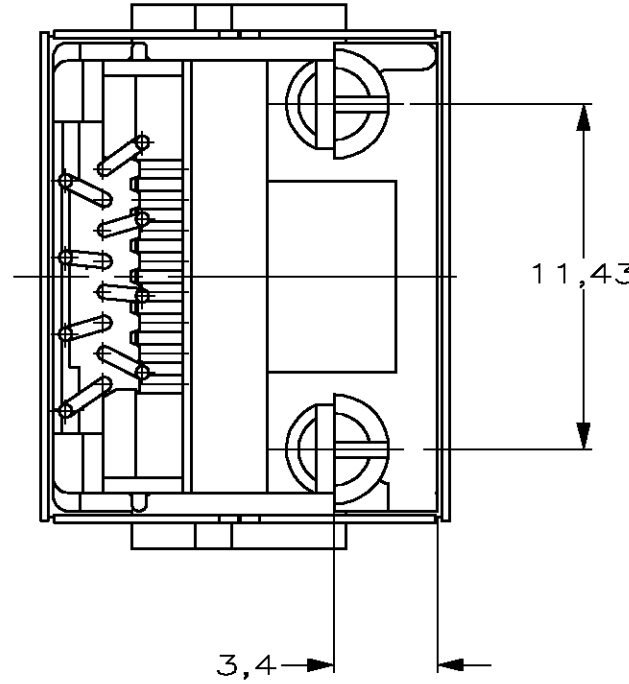
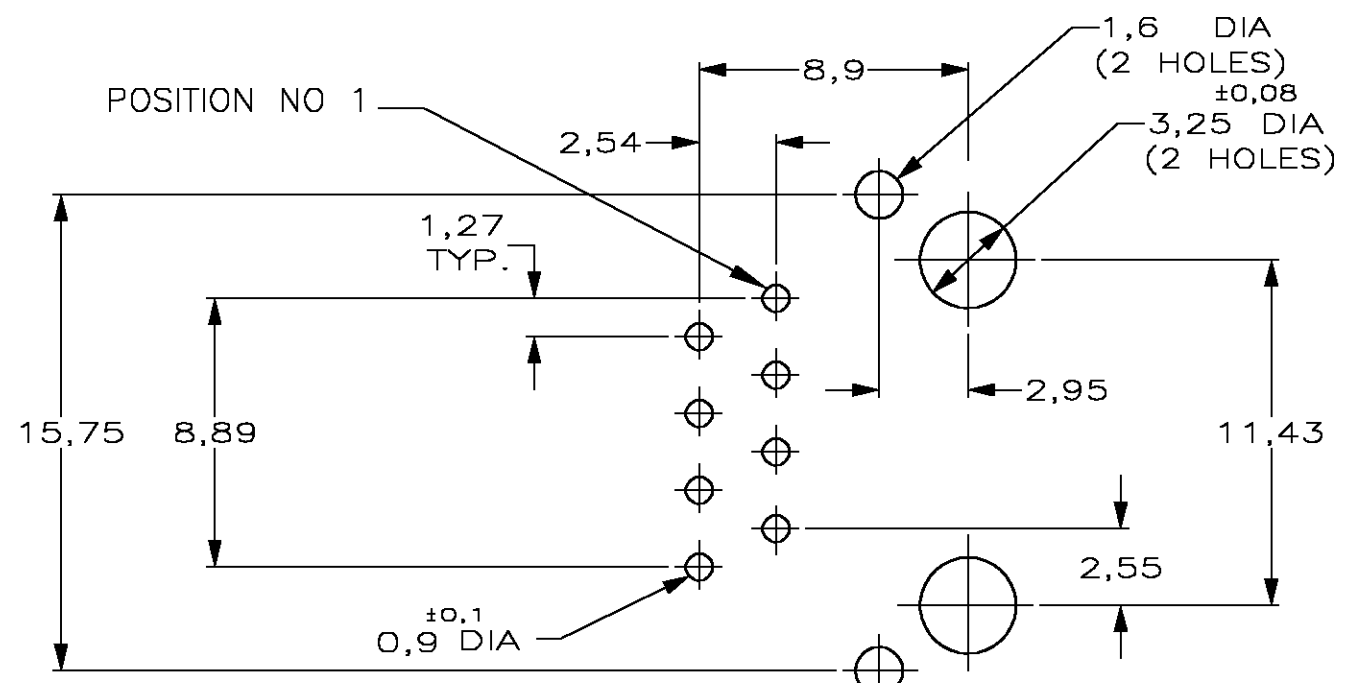
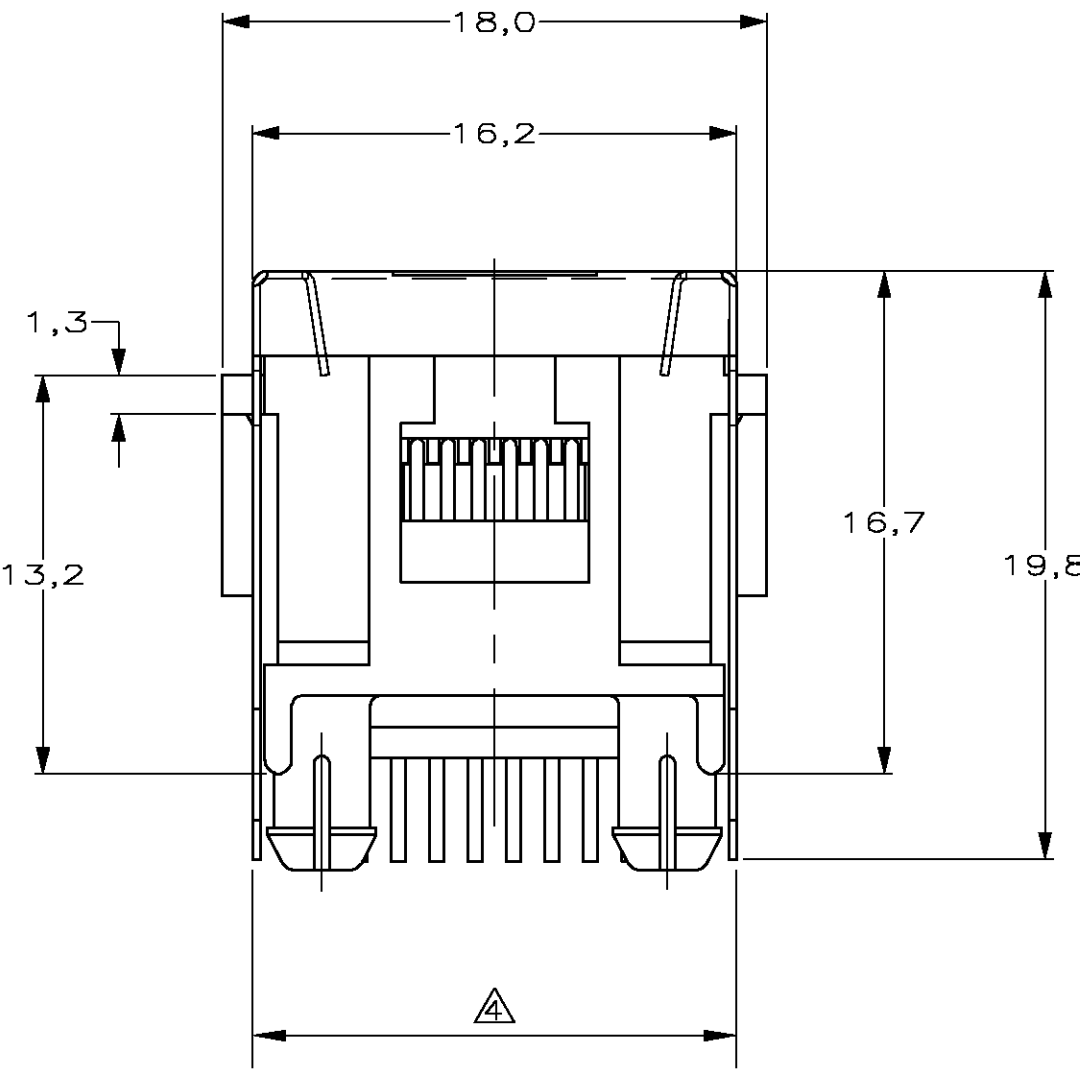
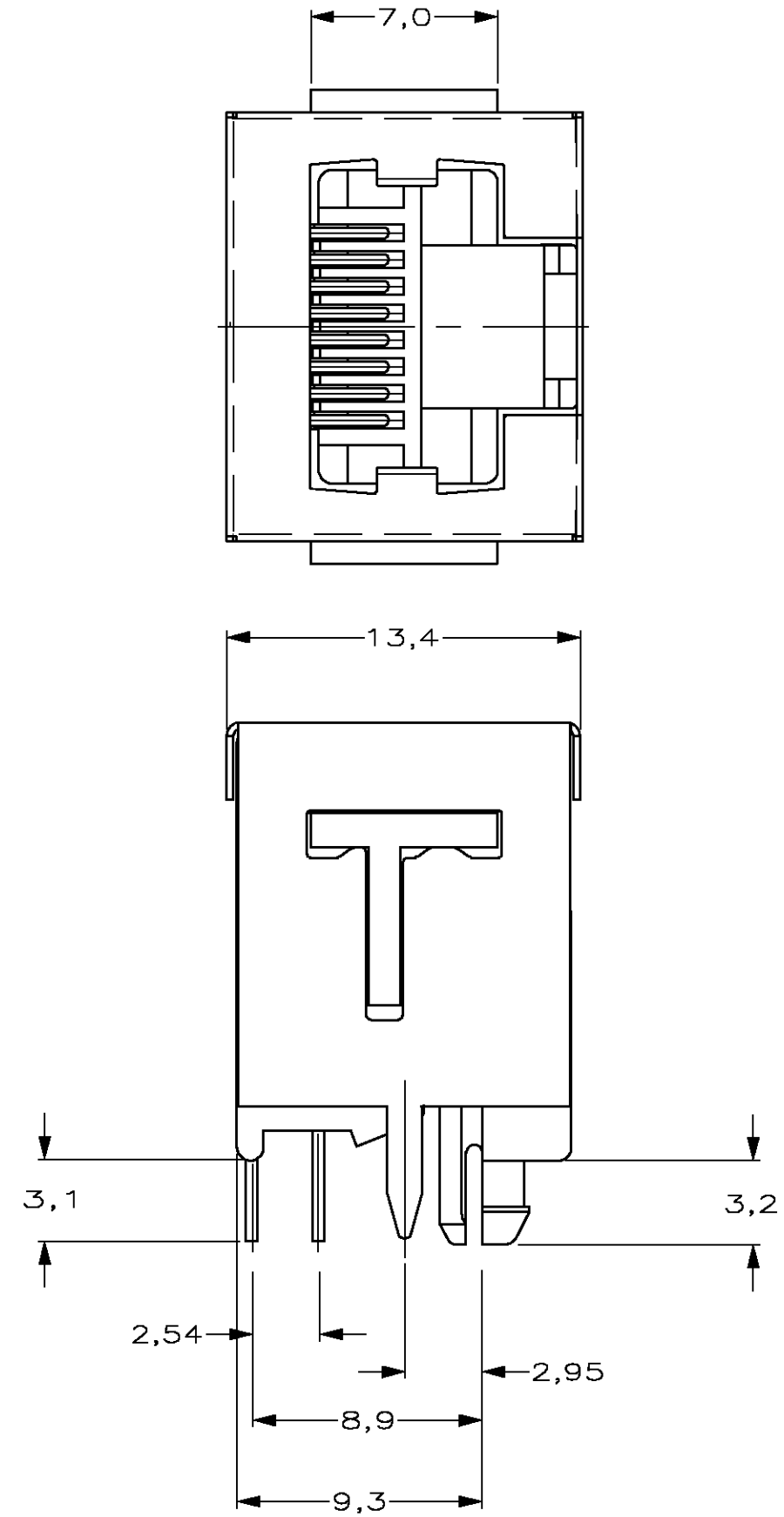
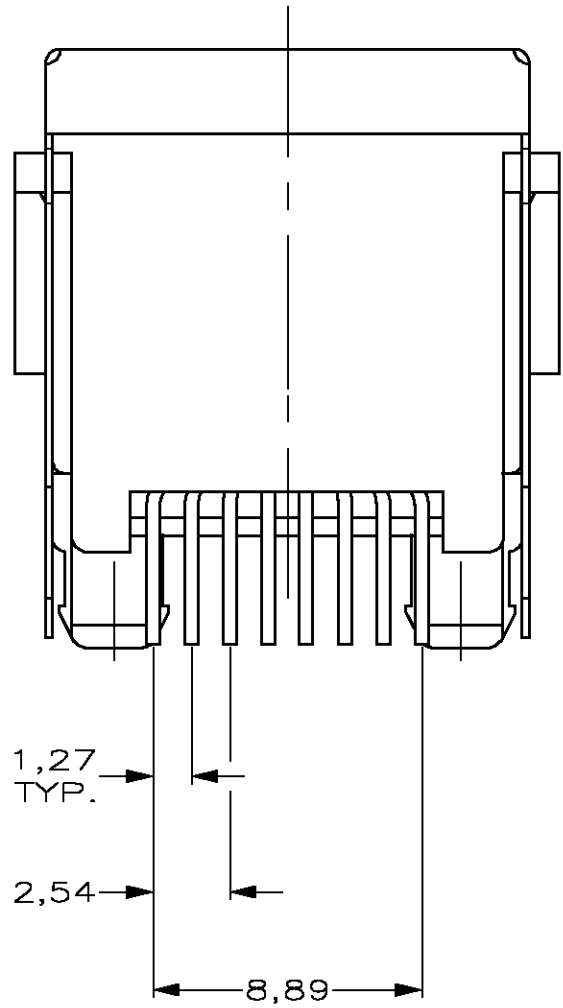


- NOTES:
- 1

TOLERANCES UNLESS OTHERWISE SPECIFIED: $\pm 0,15$
- 2

FOR APPLICATION INFORMATION SEE AMP SPEC. 114-19019.
- 3

FOR PERFORMANCE REQUIREMENTS SEE AMP SPEC. 108-19064
- THIS DIMENSION CONCERNING THE GROUNDING TIPS OF THE SHIELD IS NOT GUARANTEED PRIOR TO MOUNTING ON THE PCB



PRINTED CIRCUIT BOARD LAYOUT

VIEW SHOWN IS CIRCUIT (NONCOMPONENT) SIDE OF BOARD.
TOLERANCES UNLESS OTHERWISE SPECIFIED: $\pm 0,05$.
PRINTED CIRCUIT BOARD THICKNESS: 1,6 mm NOMINAL.

BLISTER (1080 pcs. IN A BOX)	8 POSITIONS/ 8 CONTACTS.	IN CONTACT AREA: 1,2µm MIN. SEL. GOLD OVER 1,2µm MIN. NICKEL				HOUSING: PBT,UL 94—V0 COLOR: BLACK		100616—2
		SOLDER TINES: 2,0µm MIN. TIN—LEAD OVER 1,2µm MIN. NICKEL				CONTACTS: PHOSPHOR BRONZE SHIELD: PHOSPHOR BRONZE, PRE—PLATED BRIGHT TIN\LEAD		
PACKAGING	REMARKS	FINISH				HOUSING: PBT,UL 94—HB COLOR: BLACK		100616—1
						CONTACTS: PHOSPHOR BRONZE SHIELD: PHOSPHOR BRONZE, PRE—PLATED BRIGHT TIN\LEAD		
						MATERIAL	PARTNUMBER	
						CUSTOMER DRAWING		FOR REFERENCE ONLY WILL NOT BE UPDATED
M	SR10—0083—03	KV	KV	10 MAR 03	© COPYRIGHT 19 BY AMP HOLLAND B.V. ALL INTERNATIONAL RIGHTS RESERVED.AMP PRODUCTS MAY BE COVERED BY U.S. AND FOREIGN AND/OR PATENTS PENDING. THIS DRAWING IS UNPUBLISHED RELEASED FOR PUBLICATION _____,19_____			
L	SR10—0512—02	KV	KV	04 DEC 02	 Tyco Electronics Corporation Oostkamp — BELGIUM			
K	SR10—0329—02	KV	KV	27 JUN 02				
J	EH—0041—99	JG	ME	12 JAN 99	NAME MODULAR JACK 8 POS. TOP ENTRY SHIELDED WITH PANEL STOP FOR PRINTED CIRCUIT BOARD			
H	EH—0049—97	EvE	ME	20 JAN 97				
G	EH—0539—96	GC	GC	26 APR 96				
LTR.	REVISION RECORD			DR.	CHK.	DATE		
DR.: R.HOGEVEEN DATE: 03—12—91		CHK.: W.BRUMMANS DATE: 30—03—92		APP.: L.v.SOEST DATE: 01—04—92		DWG.No. C—100616		REV.LTR. M
								SHEET 1 OF 1
								A2